Unit: mm

TOSHIBA Diode

Epitaxial Schottky Barrier Type

HN2S04FU

High-Speed Switching Application

• The HN2S04FU consists of three separate diodes.

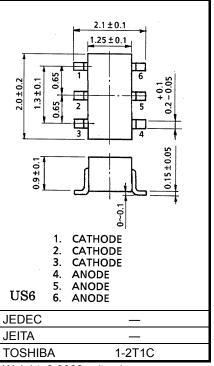
• Low forward voltage: V_{F (3)} = 0.36V (typ.)

Low reverse current: I_R= 50 μA (max)

Small total capacitance: C_T = 46 pF (typ.)

Absolute Maximum Ratings (Ta = 25°C)

| Characteristics | Symbol | Rating | Unit |
|--------------------------------|------------------|------------|------|
| Maximum (peak) reverse Voltage | V_{RM} | 25 | V |
| Reverse voltage | V _R | 20 | V |
| Maximum (peak) forward current | I _{FM} | 450 * | mA |
| Average forward current | Io | 200 * | mA |
| Surge current (10 ms) | I _{FSM} | 1 * | Α |
| Power dissipation | Р | 200 ** | mW |
| Junction temperature | Tj | 125 | °C |
| Storage temperature range | T _{stg} | −55 to 125 | °C |
| Operating temperature range | T _{opr} | -40 to 100 | °C |



Weight: 0.0062 g (typ.)

*: Per one diode.

When more than one diode is used, the surge current rating is reduced to 75% of I_{FSM} .

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

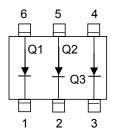
Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Electrical Characteristics (Q1, Q2, Q3 Common, Ta = 25°C)

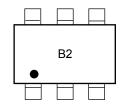
| Characteristics | Symbol | Test Condition | Min | Тур. | Max | Unit |
|-------------------|--------------------|--|-----|------|------|------|
| Forward voltage | V _{F (1)} | I _F = 1 mA | _ | 0.16 | _ | V |
| | V _{F (2)} | I _F = 10 mA | _ | 0.22 | _ | |
| | V _{F (3)} | I _F = 200 mA | _ | 0.36 | 0.42 | |
| Reverse current | I _R | V _R = 20 V | _ | _ | 50 | μΑ |
| Total capacitance | C _T | V _R = 0, f = 1MH _z | _ | 46 | _ | pF |

^{**:} Total rating

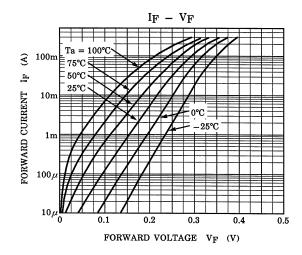
Pin Assignment (top view)

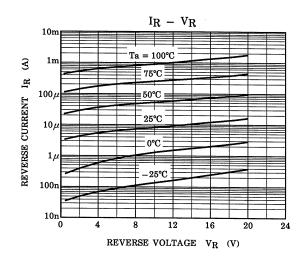


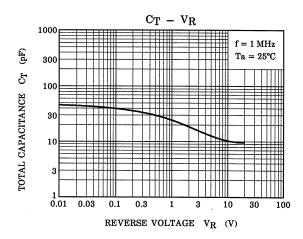
Marking

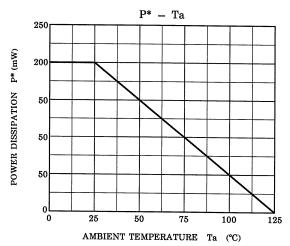


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* : Total Rating

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